

Electronic Acknowledgement Receipt

EFS ID:	1400066
Application Number:	10810965
International Application Number:	
Confirmation Number:	9818
Title of Invention:	Novel method to improve bump reliability for flip chip device
First Named Inventor/Applicant Name:	Yen-Ming Chen
Customer Number:	47390
Filer:	Daniel R. McClure
Filer Authorized By:	
Attorney Docket Number:	TS01-0413C
Receipt Date:	26-DEC-2006
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Application Type:	Utility

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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Appeal Brief Filed	00463949.pdf	179277	no	19

Warnings:

Information:**Total Files Size (in bytes):**

179277

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New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.